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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	78K/0
Core Size	8-Bit
Speed	20MHz
Connectivity	3-Wire SIO, I²C, LINbus, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	23
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	36-VFLGA
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/upd78f0503afc-aa3-a

Differences Between Conventional-specification Products and Expanded-specification Products

The differences between the conventional-specification products (μPD78F05xx, 78F05xxD) and expanded-specification products (μPD78F05xxA, 78F05xxDA) of the 78K0/Kx2 microcontrollers are described below.

- A/D conversion time
- X1 oscillator characteristics
- Instruction cycle, peripheral hardware clock frequency, external main system clock frequency, external main system clock input high-level width, and external main system clock input low-level width (AC characteristics)
- The number of flash memory rewrites and retention time
- Processing time of the self programming library
- Interrupt response time of the self programming library

For details, see **1.1 Differences Between Conventional-specification Products (μPD78F05xx, 78F05xxD) and Expanded-specification Products (μPD78F05xxA, 78F05xxDA).**

Purpose

This manual is intended to give users an understanding of the functions described in the **Organization** below.

Organization

The manual for the 78K0/Kx2 microcontrollers is separated into two parts: this manual and the instructions edition (common to the 78K0 microcontrollers).

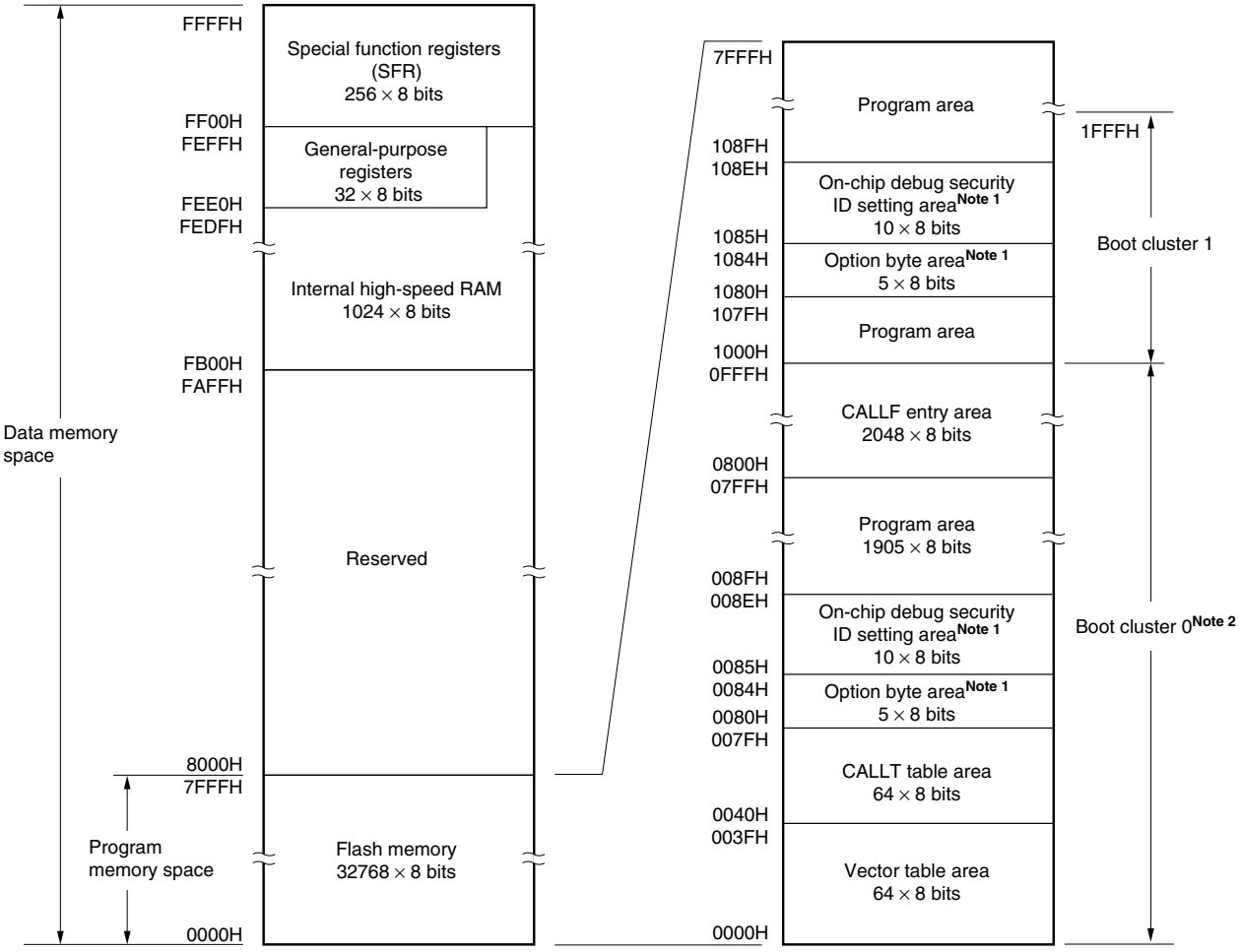
78K0/Kx2 User's Manual (This Manual)	**78K/0 Series User's Manual Instructions**
• Pin functions • Internal block functions • Interrupts • Other on-chip peripheral functions • Electrical specifications	• CPU functions • Instruction set • Explanation of each instruction

How to Read This Manual

It is assumed that the readers of this manual have general knowledge of electrical engineering, logic circuits, and microcontrollers.

- When using this manual as the manual for (A) grade products and (A2) grade products of the 78K0/Kx2 microcontrollers:
  → Only the quality grade differs between standard products and (A), (A2) grade products. Read the part number as follows.
  - μPD78F05xx→ μPD78F05xx(A), 78F05xx(A2)
  - μPD78F05xxA→ μPD78F05xxA(A), 78F05xxA(A2)
- To gain a general understanding of functions:
  → Read this manual in the order of the **CONTENTS**. The mark "<R>" shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.
- How to interpret the register format:
  → For a bit number enclosed in angle brackets, the bit name is defined as a reserved word in the RA78K0, and is defined as an sfr variable using the #pragma sfr directive in the CC78K0.
- To check the details of a register when you know the register name:
  → See **APPENDIX C REGISTER INDEX**.

Figure 3-5. Memory Map (μPD78F0503D, 78F0503DA, 78F0513D, and 78F0513DA)

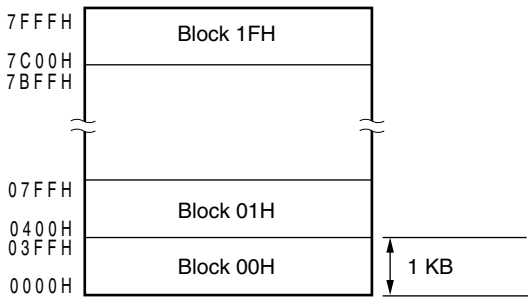


Notes 1. When boot swap is not used: Set the option bytes to 0080H to 0084H, and the on-chip debug security IDs to 0085H to 008EH.

When boot swap is used: Set the option bytes to 0080H to 0084H and 1080H to 1084H, and the on-chip debug security IDs to 0085H to 008EH and 1085H to 108EH.

2. Writing boot cluster 0 can be prohibited depending on the setting of security (see **27.8 Security Settings**).

Remark The flash memory is divided into blocks (one block = 1 KB). For the address values and block numbers, see **Table 3-3 Correspondence Between Address Values and Block Numbers in Flash Memory**.



3.1.4 Special function register (SFR) area

On-chip peripheral hardware special function registers (SFRs) are allocated in the area FF00H to FFFFH (see **Table 3-8 Special Function Register List** in **3.2.3 Special function registers (SFRs)**).

Caution Do not access addresses to which SFRs are not assigned.

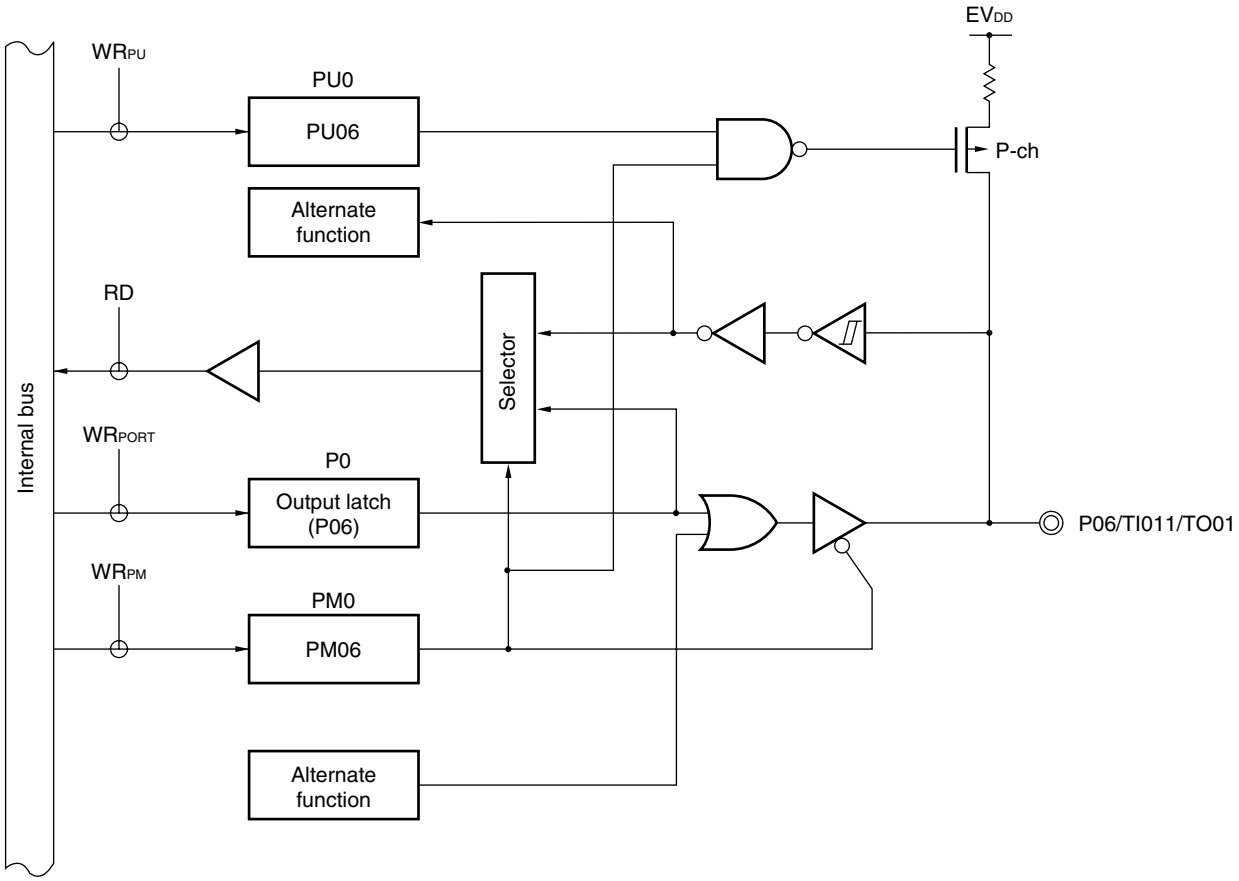
3.1.5 Data memory addressing

Addressing refers to the method of specifying the address of the instruction to be executed next or the address of the register or memory relevant to the execution of instructions.

Several addressing modes are provided for addressing the memory relevant to the execution of instructions for the 78K0/Kx2 microcontrollers, based on operability and other considerations. For areas containing data memory in particular, special addressing methods designed for the functions of special function registers (SFR) and general-purpose registers are available for use. Figures 3-12 to 3-19 show correspondence between data memory and addressing. For details of each addressing mode, see **3.4 Operand Address Addressing**.

Figure 5-6. Block Diagram of P06 (2/2)

(2) 78K0/KE2 products whose flash memory is at least 48 KB and 78K0/KF2

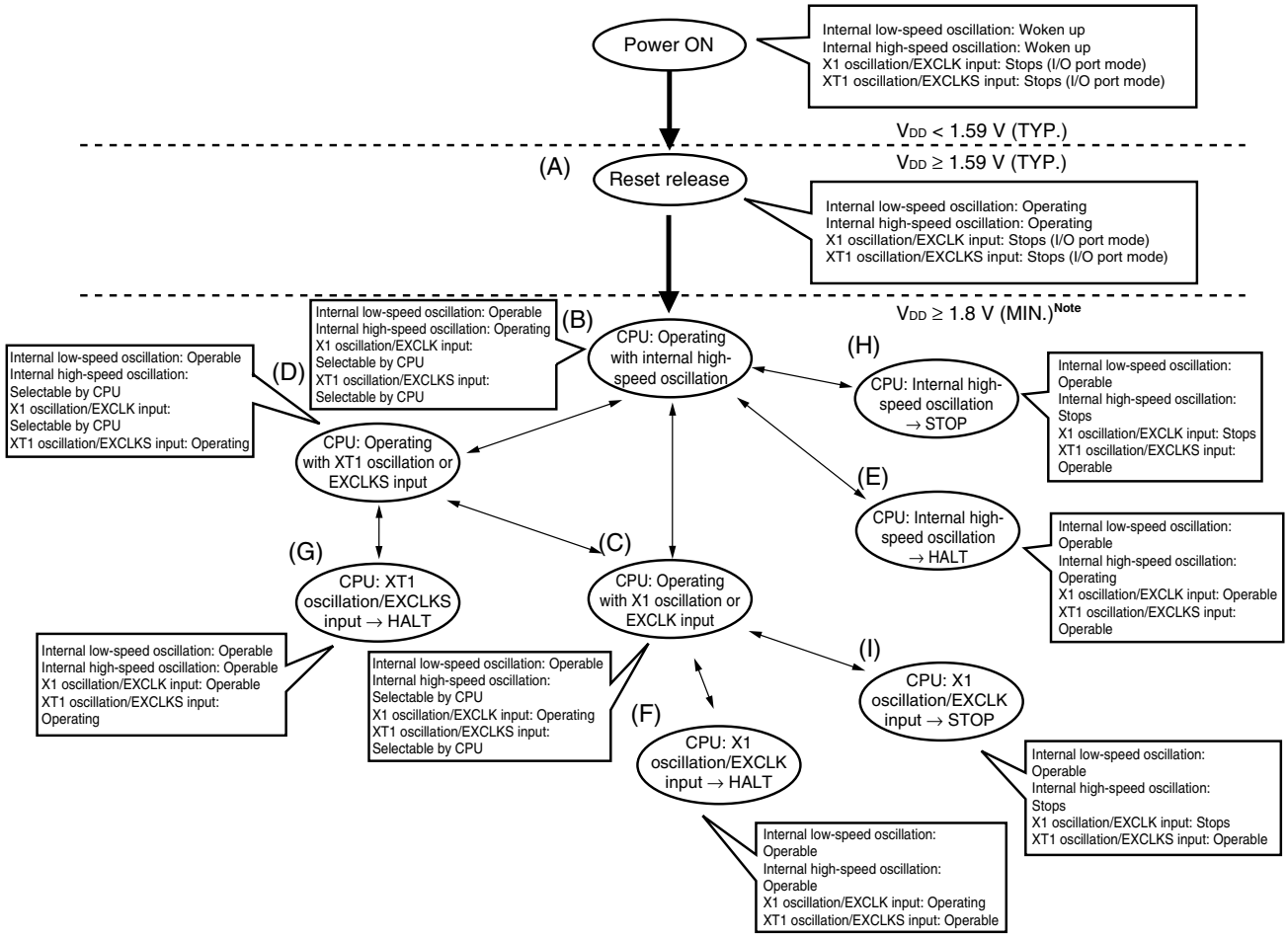


P0: Port register 0
PU0: Pull-up resistor option register 0
PM0: Port mode register 0
RD: Read signal
WR××: Write signal

Remark With products not provided with an EV_{DD} or EV_{SS} pin, replace EV_{DD} with V_{DD}, or replace EV_{SS} with V_{SS}.

Figure 6-18. CPU Clock Status Transition Diagram
(When 1.59 V POC Mode Is Set (Option Byte: POCMODE = 0),
78K0/KC2, 78K0/KD2, 78K0/KE2, and 78K0/KF2)

<R>



Note Standard and (A) grade products: 1.8 V,
(A2) grade products: 2.7 V

Remark In the 2.7 V/1.59 V POC mode (option byte: POCMODE = 1), the CPU clock status changes to (A) in the above figure when the supply voltage exceeds 2.7 V (TYP.), and to (B) after reset processing (11 to 45 μs).

Table 6-6. CPU Clock Transition and SFR Register Setting Examples (2/5)

(4) CPU clock changing from internal high-speed oscillation clock (B) to high-speed system clock (C)

(Setting sequence of SFR registers) →

Setting Flag of SFR Register / Status Transition	AMPH[Note]	EXCLK	OSCSEL	MSTOP	OSTC Register	XSEL[Note]	MCM0
(B) → (C) (X1 clock: 1 MHz ≤ f_{XH} ≤ 10 MHz)	0	0	1	0	Must be checked	1	1
(B) → (C) (external main clock: 1 MHz ≤ f_{XH} ≤ 10 MHz)	0	1	1	0	Must not be checked	1	1
(B) → (C) (X1 clock: 10 MHz < f_{XH} ≤ 20 MHz)	1	0	1	0	Must be checked	1	1
(B) → (C) (external main clock: 10 MHz < f_{XH} ≤ 20 MHz)	1	1	1	0	Must not be checked	1	1

Unnecessary if these registers are already set

Unnecessary if the CPU is operating with the high-speed system clock

Note The value of this flag can be changed only once after a reset release. This setting is not necessary if it has already been set.

Caution Set the X1 clock after the supply voltage has reached the operable voltage of the clock to be used (see CHAPTER 30 ELECTRICAL SPECIFICATIONS (STANDARD PRODUCTS) to CHAPTER 33 ELECTRICAL SPECIFICATIONS ((A2) GRADE PRODUCTS: T_A = –40 to +125°C)).

(5) CPU clock changing from internal high-speed oscillation clock (B) to subsystem clock (D)[Note]

Note The 78K0/KB2 is not provided with a subsystem clock.

(Setting sequence of SFR registers) →

Setting Flag of SFR Register / Status Transition	XTSTART	EXCLKS	OSCSELS	Waiting for Oscillation Stabilization	CSS
(B) → (D) (XT1 clock)	0	0	1	Necessary	1
	1	×	×		
(B) → (D) (external subsystem clock)	0	1	1	Unnecessary	1

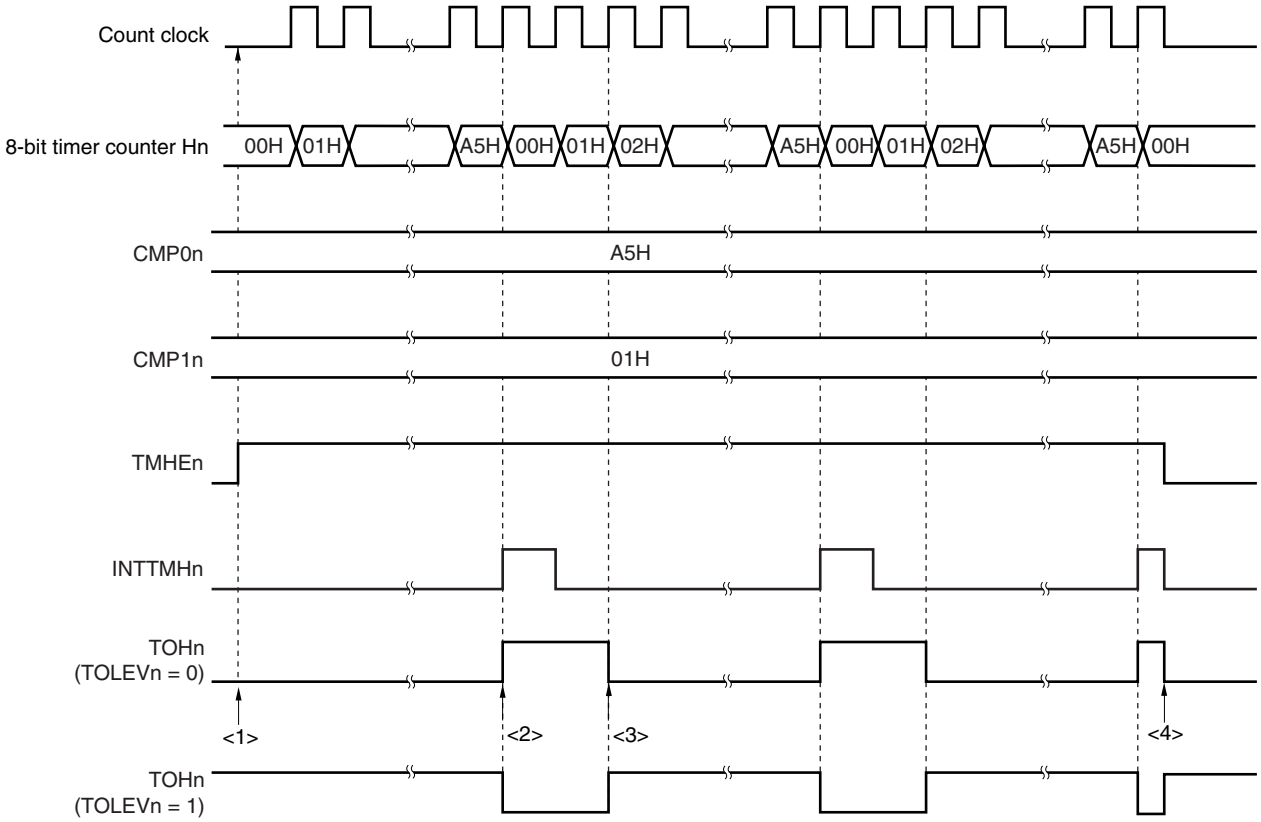
Unnecessary if the CPU is operating with the subsystem clock

Remarks 1. (A) to (I) in Table 6-6 correspond to (A) to (I) in Figure 6-17 and 6-18.

2. EXCLK, OSCSEL, EXCLKS, OSCSELS, AMPH: Bits 7 to 4 and 0 of the clock operation mode select register (OSCCTL)
MSTOP: Bit 7 of the main OSC control register (MOC)
XSEL, MCM0: Bits 2 and 0 of the main clock mode register (MCM)
XTSTART, CSS: Bits 6 and 4 of the processor clock control register (PCC)
×: Don't care

Figure 9-12. Operation Timing in PWM Output Mode (1/4)

(a) Basic operation



<1> The count operation is enabled by setting the TMHEn bit to 1. Start the 8-bit timer counter Hn by masking one count clock to count up. At this time, PWM output outputs an inactive level.

<2> When the values of the 8-bit timer counter Hn and the CMP0n register match, an active level is output. At this time, the value of the 8-bit timer counter Hn is cleared, and the INTTMHn signal is output.

<3> When the values of the 8-bit timer counter Hn and the CMP1n register match, an inactive level is output. At this time, the 8-bit timer counter value is not cleared and the INTTMHn signal is not output.

<4> Clearing the TMHEn bit to 0 during timer Hn operation sets the INTTMHn signal to the default and PWM output to an inactive level.

Remark n = 0, 1

14.4 Operation of Serial Interface UART0

Serial interface UART0 has the following two modes.

- Operation stop mode
- Asynchronous serial interface (UART) mode

14.4.1 Operation stop mode

In this mode, serial communication cannot be executed, thus reducing the power consumption. In addition, the pins can be used as ordinary port pins in this mode. To set the operation stop mode, clear bits 7, 6, and 5 (POWER0, TXE0, and RXE0) of ASIM0 to 0.

(1) Register used

The operation stop mode is set by asynchronous serial interface operation mode register 0 (ASIM0).

ASIM0 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 01H.

Address: FF70H After reset: 01H R/W

Symbol	<7>	<6>	<5>	4	3	2	1	0
ASIM0	POWER0	TXE0	RXE0	PS01	PS00	CL0	SL0	1

POWER0	Enables/disables operation of internal operation clock
0[Note 1]	Disables operation of the internal operation clock (fixes the clock to low level) and asynchronously resets the internal circuit[Note 2].

TXE0	Enables/disables transmission
0	Disables transmission (synchronously resets the transmission circuit).

RXE0	Enables/disables reception
0	Disables reception (synchronously resets the reception circuit).

Notes 1. The input from the RxD0 pin is fixed to high level when POWER0 = 0.

2. Asynchronous serial interface reception error status register 0 (ASIS0), transmit shift register 0 (TXS0), and receive buffer register 0 (RXB0) are reset.

Caution Clear POWER0 to 0 after clearing TXE0 and RXE0 to 0 to set the operation stop mode. To start the communication, set POWER0 to 1, and then set TXE0 or RXE0 to 1.

Remark To use the RxD0/SI10/P11 and TxD0/$\overline{\text{SCK10}}$/P10 pins as general-purpose port pins, see **CHAPTER 5 PORT FUNCTIONS**.

Figure 16-8. Format of Port Mode Register 1 (PM1)

Address: FF21H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
PM1	PM17	PM16	PM15	PM14	PM13	PM12	PM11	PM10

PM1n	P1n pin I/O mode selection (n = 0 to 7)
0	Output mode (output buffer on)
1	Input mode (output buffer off)

16.4 Operation of Serial Interfaces CSI10 and CSI11

Serial interfaces CSI10 and CSI11 can be used in the following two modes.

- Operation stop mode
- 3-wire serial I/O mode

16.4.1 Operation stop mode

Serial communication is not executed in this mode. Therefore, the power consumption can be reduced. In addition, the P10/$\overline{\text{SCK10}}$/TxD0, P11/SI10/RxD0, P12/SO10, P02/SO11, P03/SI11, and P04/$\overline{\text{SCK11}}$ pins can be used as ordinary I/O port pins in this mode.

(1) Register used

The operation stop mode is set by serial operation mode register 1n (CSIM1n).

To set the operation stop mode, clear bit 7 (CSIE1n) of CSIM1n to 0.

(a) Serial operation mode register 1n (CSIM1n)

CSIM1n can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation clears CSIM1n to 00H.

Remark n = 0: 78K0/KE2 products whose flash memory is less than 32 KB, and 78K0/KB2, 78K0/KC2, 78K0/KD2 products

n = 0, 1: 78K0/KE2 products whose flash memory is at least 48 KB, and 78K0/KF2 products

- Serial operation mode register 10 (CSIM10)

Address: FF80H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIM10	CSIE10	TRMD10	0	DIR10	0	0	0	CSOT10

CSIE10	Operation control in 3-wire serial I/O mode
0	Disables operation[Note 1] and asynchronously resets the internal circuit[Note 2].

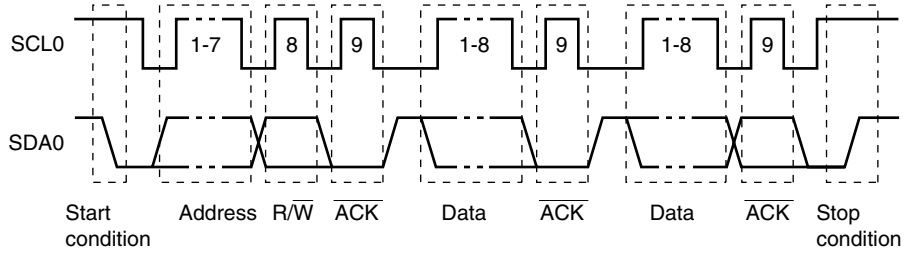
Notes 1. To use P10/$\overline{\text{SCK10}}$/TxD0 and P12/SO10 as general-purpose ports, set CSIM10 in the default status (00H).

2. Bit 0 (CSOT10) of CSIM10 and serial I/O shift register 10 (SIO10) are reset.

18.5 I^2C Bus Definitions and Control Methods

The following section describes the I^2C bus's serial data communication format and the signals used by the I^2C bus. Figure 18-12 shows the transfer timing for the "start condition", "address", "data", and "stop condition" output via the I^2C bus's serial data bus.

Figure 18-12. I^2C Bus Serial Data Transfer Timing



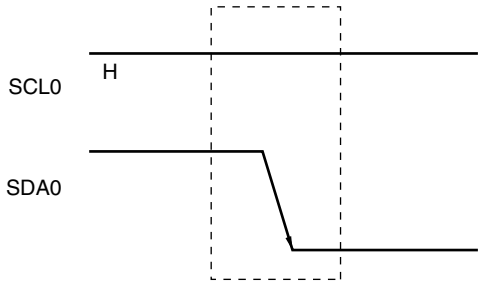
The master device generates the start condition, slave address, and stop condition.
The acknowledge ($\overline{ACK}$) can be generated by either the master or slave device (normally, it is output by the device that receives 8-bit data).

The serial clock (SCL0) is continuously output by the master device. However, in the slave device, the SCL0's low level period can be extended and a wait can be inserted.

18.5.1 Start conditions

A start condition is met when the SCL0 pin is at high level and the SDA0 pin changes from high level to low level. The start conditions for the SCL0 pin and SDA0 pin are signals that the master device generates to the slave device when starting a serial transfer. When the device is used as a slave, start conditions can be detected.

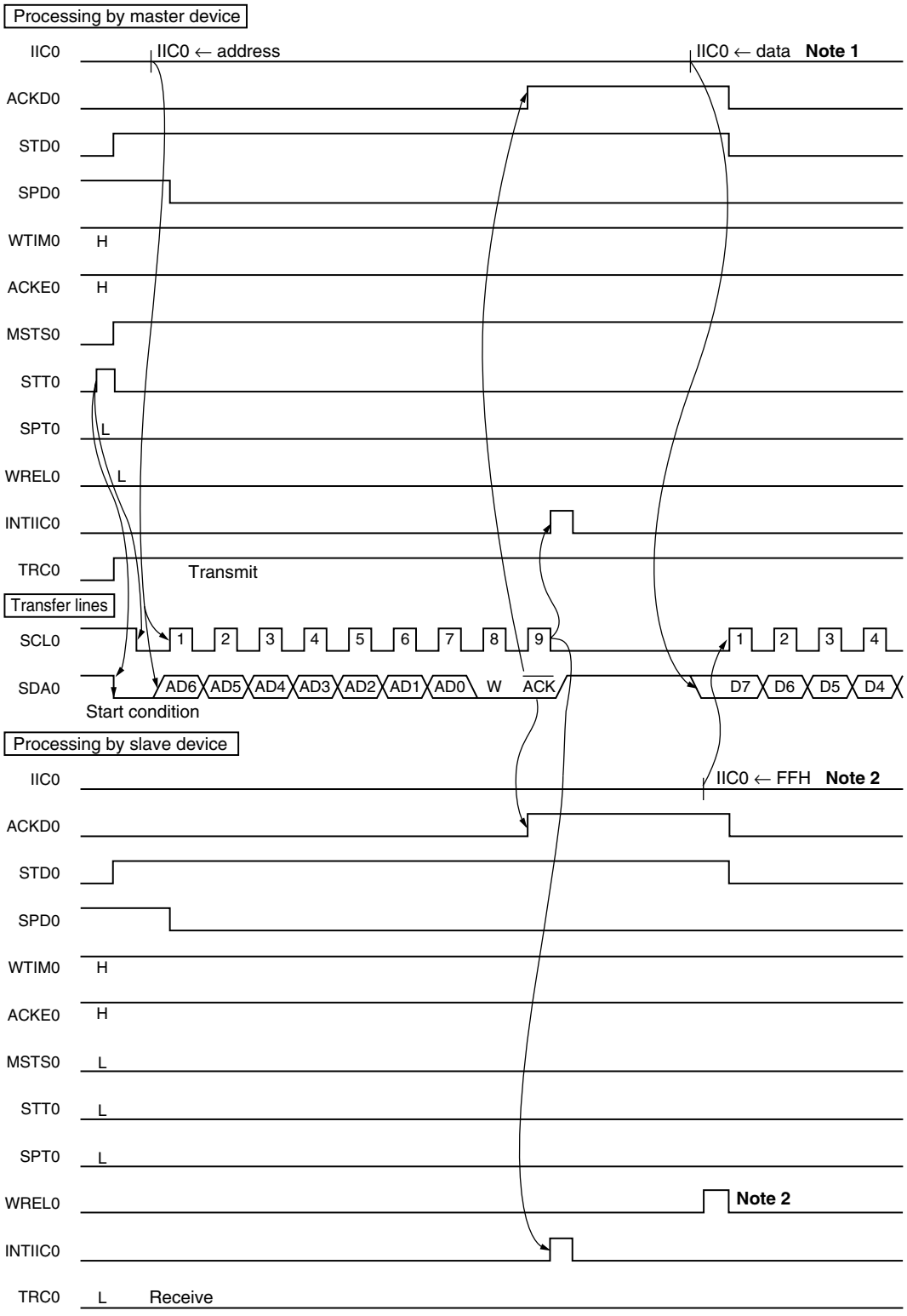
Figure 18-13. Start Conditions



A start condition is output when bit 1 (STT0) of IIC control register 0 (IICC0) is set (to 1) after a stop condition has been detected (SPD0: Bit 0 = 1 in IIC status register 0 (IICS0)). When a start condition is detected, bit 1 (STD0) of IICS0 is set (to 1).

Figure 18-27. Example of Master to Slave Communication (When 9-Clock Wait Is Selected for Both Master and Slave) (1/3)

(1) Start condition ~ address



Notes 1. Write data to IIC0, not setting WREL0, in order to cancel a wait state during master transmission.

2. To cancel slave wait, write “FFH” to IIC0 or set WREL0.

Figure 20-14. Format of Priority Specification Flag Registers (PR0L, PR0H, PR1L, PR1H) (78K0/KD2)

Address: FFE8H After reset: FFH R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
PR0L	SREPR6	PPR5	PPR4	PPR3	PPR2	PPR1	PPR0	LVIPR

Address: FFE9H After reset: FFH R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
PR0H	TMPR010	TMPR000	TMPR50	TMPRH0	TMPRH1	DUALPR0 CSIPR10 STPR0	STPR6	SRPR6

Address: FFEAH After reset: FFH R/W

Symbol	7	<6>	<5>	<4>	<3>	<2>	<1>	<0>
PR1L	1	PPR6	WTPR	KRPR	TMPR51	WTIPR	SRPR0	ADPR

Address: FFEBH After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	<0>
PR1H	1	1	1	1	1	1	1	IICPR0 DMUPR[Note]

XXPRX	Priority level selection
0	High priority level
1	Low priority level

Note Products whose flash memory is at least 48 KB only.

Caution Be sure to set bit 7 of PR1L and bits 1 to 7 of PR1H to 1.

(3) 0084H/1084H

○ On-chip debug operation control

- Disabling on-chip debug operation
- Enabling on-chip debug operation and erasing data of the flash memory in case authentication of the on-chip debug security ID fails
- Enabling on-chip debug operation and not erasing data of the flash memory even in case authentication of the on-chip debug security ID fails

Cautions 1. Be sure to set 00H (disabling on-chip debug operation) to 0084H for products not equipped with the on-chip debug function (μPD78F05xx and 78F05xxA). Also set 00H to 1084H because 0084H and 1084H are switched during the boot operation.

2. To use the on-chip debug function with a product equipped with the on-chip debug function (μPD78F05xxD and 78F05xxDA), set 02H or 03H to 0084H. Set a value that is the same as that of 0084H to 1084H because 0084H and 1084H are switched during the boot operation.

26.2 Format of Option Byte

The format of the option byte is shown below.

Table 27-13. Processing Time for Self Programming Library
(Conventional-specification Products (μPD78F05xx and 78F05xxD)) (2/4)

(2) When internal high-speed oscillation clock is used and entry RAM is located in short direct addressing range

Library Name		Processing Time (μs)			
		Normal Model of C Compiler		Static Model of C Compiler/Assembler	
		Min.	Max.	Min.	Max.
Self programming start library		4.25			
Initialize library		443.5			
Mode check library		219.625		218.875	
Block blank check library		12236.625		12231.625	
Block erase library		36363.25	355771.75	36358.25	355750
Word write library		679.75 (680.125)	1874.75 (1875.125)	672.75 (673.125)	1867.75 (1868.125)
Block verify library		25072.625		25067.625	
Self programming end library		4.25			
Get information library	Option value: 03H	337 (337.125)		331.75 (331.875)	
	Option value: 04H	329.125 (239.25)		323.875 (324)	
	Option value: 05H	502.25 (503.125)		497 (497.875)	
Set information library		104978.5	541143.125	104977.5	541142.125
EEPROM write library		962.25 (962.625)	2157.25 (2157.625)	955.25 (955.625)	2150.25 (2150.625)

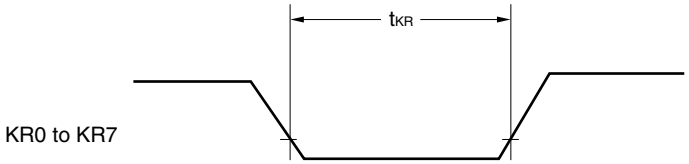
Remarks 1. Values in parentheses indicate values when a write start address structure is located other than in the internal high-speed RAM.

2. The above processing times are those during stabilized operation of the internal high-speed oscillator (RSTS = 1).

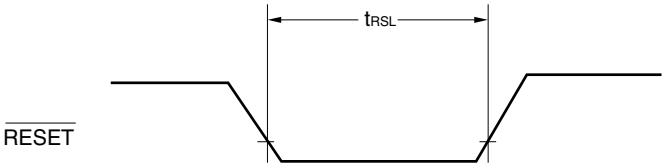
3. RSTS: Bit 7 of the internal oscillation mode register (RCM)

Caution The pins mounted depend on the product. Refer to Caution 2 at the beginning of this chapter.

Key Interrupt Input Timing



$\overline{\text{RESET}}$ Input Timing

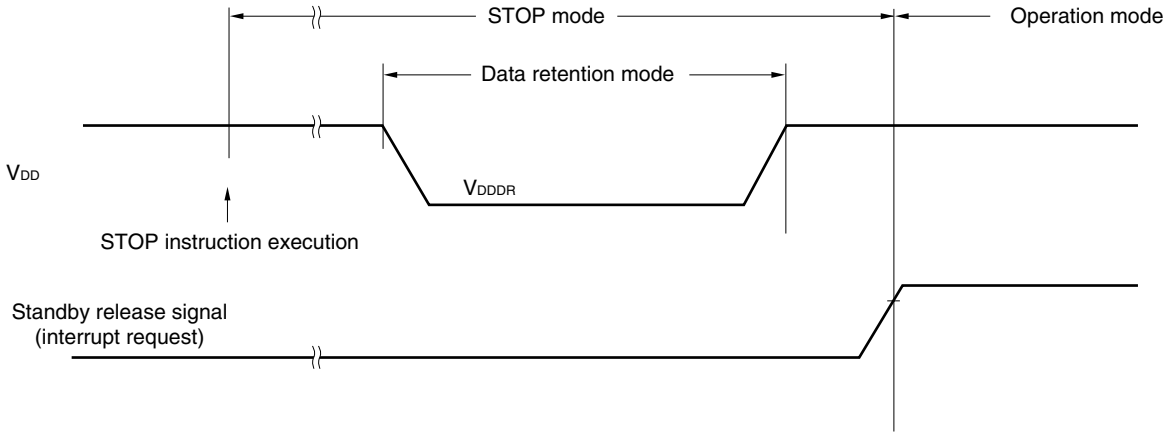


Caution The pins mounted depend on the product. Refer to Caution 2 at the beginning of this chapter.

Data Memory STOP Mode Low Supply Voltage Data Retention Characteristics (T_A = –40 to +85°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	V_{DDDR}		1.44[Note]		5.5	V

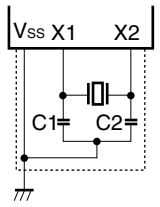
Note The value depends on the POC detection voltage. When the voltage drops, the data is retained until a POC reset is effected, but data is not retained when a POC reset is effected.



Caution The pins mounted depend on the product. Refer to Caution at the beginning of this chapter.

X1 Oscillator Characteristics

(T_A = –40 to +85°C, 1.8 V ≤ V_{DD} = EV_{DD} ≤ 5.5 V, V_{SS} = EV_{SS} = AV_{SS} = 0 V)

Resonator	Recommended Circuit	Parameter	Conditions		MIN.	TYP.	MAX.	Unit
Ceramic resonator, Crystal resonator		X1 clock oscillation frequency (f_X)Note 1	Conventional-specification Products (μPD78F05xx (A))	4.0 V ≤ V_{DD} ≤ 5.5 V	1.0Note 2		20.0	MHz
				2.7 V ≤ V_{DD} < 4.0 V	1.0Note 2		10.0	
				1.8 V ≤ V_{DD} < 2.7 V	1.0		5.0	
			Expanded-specification Products (μPD78F05xxA (A))	2.7 V ≤ V_{DD} ≤ 5.5 V	1.0Note 2		20.0	MHz
				1.8 V ≤ V_{DD} < 2.7 V	1.0		5.0	

Notes 1. Indicates only oscillator characteristics. Refer to **AC Characteristics** for instruction execution time.

2. It is 2.0 MHz (MIN.) when programming on the board via UART6.

Cautions 1. When using the X1 oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- **Keep the wiring length as short as possible.**
- **Do not cross the wiring with the other signal lines.**
- **Do not route the wiring near a signal line through which a high fluctuating current flows.**
- **Always make the ground point of the oscillator capacitor the same potential as V_{SS}.**
- **Do not ground the capacitor to a ground pattern through which a high current flows.**
- **Do not fetch signals from the oscillator.**

2. Since the CPU is started by the internal high-speed oscillation clock after a reset release, check the X1 clock oscillation stabilization time using the oscillation stabilization time counter status register (OSTC) by the user. Determine the oscillation stabilization time of the OSTC register and oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.

Remark For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.

CHAPTER 32 ELECTRICAL SPECIFICATIONS ((A2) GRADE PRODUCTS: T_A = –40 to +110°C)

Target Products	Conventional-specification Products	Expanded-specification Products
78K0/KB2	μPD78F0500(A2), 78F0501(A2), 78F0502(A2), 78F0503(A2)	μPD78F0500A(A2), 78F0501A(A2), 78F0502A(A2), 78F0503A(A2)
78K0/KC2	μPD78F0511(A2), 78F0512(A2), 78F0513(A2), 78F0514(A2), 78F0515(A2)	μPD78F0511A(A2), 78F0512A(A2), 78F0513A(A2), 78F0514A(A2), 78F0515A(A2)
78K0/KD2	μPD78F0521(A2), 78F0522(A2), 78F0523(A2), 78F0524(A2), 78F0525(A2), 78F0526(A2), 78F0527(A2)	μPD78F0521A(A2), 78F0522A(A2), 78F0523A(A2), 78F0524A(A2), 78F0525A(A2), 78F0526A(A2), 78F0527A(A2)
78K0/KE2	μPD78F0531(A2), 78F0532(A2), 78F0533(A2), 78F0534(A2), 78F0535(A2), 78F0536(A2), 78F0537(A2)	μPD78F0531A(A2), 78F0532A(A2), 78F0533A(A2), 78F0534A(A2), 78F0535A(A2), 78F0536A(A2), 78F0537A(A2)
78K0/KF2	μPD78F0544(A2), 78F0545(A2), 78F0546(A2), 78F0547(A2)	μPD78F0544A(A2), 78F0545A(A2), 78F0546A(A2), 78F0547A(A2)

The following items are described separately for conventional-specification products (μPD78F05xx(A2)) and expanded-specification products (μPD78F05xxA(A2)).

- X1 clock oscillation frequency (**X1 oscillator characteristics**)
- Instruction cycle, peripheral hardware clock frequency, external main system clock frequency, external main system clock input high-level width, and external main system clock input low-level width (**(1) Basic operation** in **AC characteristics**)
- A/D conversion time (**A/D Converter Characteristics**)
- Number of rewrites per chip (**Flash Memory Programming Characteristics**)

Caution The pins mounted depend on the product as follows.

(1) Port functions

Port	78K0/KB2	78K0/KC2			78K0/KD2	78K0/KE2	78K0/KF2
	30/36 Pins	38 Pins	44 Pins	48 Pins	52 Pins	64 Pins	80 Pins
Port 0	P00, P01				P00 to P03	P00 to P06	
Port 1	P10 to P17						
Port 2	P20 to P23	P20 to P25	P20 to P27				
Port 3	P30 to P33						
Port 4	–		P40, P41			P40 to P43	P40 to P47
Port 5	–					P50 to P53	P50 to P57
Port 6	P60, P61	P60 to P63					P60 to P67
Port 7	–	P70, P71	P70 to P73	P70 to P75	P70 to P77		
Port 12	P120 to P122	P120 to P124					
Port 13	–			P130			
Port 14	–			P140		P140, P141	P140 to P145

(The remaining table is on the next page.)

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Chapter	Classification	Function	Details of Function	Cautions	Page
Chapter 4	Soft	Memory bank switching function (products whose flash memory is at least 96 KB only)	BANK: Memory bank select register	Be sure to change the value of the BANK register in the common area (0000H to 7FFFH). If the value of the BANK register is changed in the bank area (8000H to BFFFH), an inadvertent program loop occurs in the CPU. Therefore, never change the value of the BANK register in the bank area.	p. 150 ☐
			Memory bank	Instructions cannot be fetched between different memory banks.	p. 151 ☐
				Branching and accessing cannot be directly executed between different memory banks. Execute branching or accessing between different memory banks via the common area.	p. 151 ☐
				Allocate interrupt servicing in the common area.	p. 151 ☐
				An instruction that extends from 7FFFH to 8000H can only be executed in memory bank 0.	p. 151 ☐
Chapter 5	Soft	Port function	P02/SO11, P04/$\overline{\text{SCK11}}$	To use P02/SO11 and P04/$\overline{\text{SCK11}}$ as general-purpose ports, set serial operation mode register 11 (CSIM11) and serial clock selection register 11 (CSIC11) to the default status (00H).	p. 164 ☐
			P10/$\overline{\text{SCK10}}$/TxD0, P12/SO10	To use P10/$\overline{\text{SCK10}}$/TxD0 and P12/SO10 as general-purpose ports, set serial operation mode register 10 (CSIM10) and serial clock selection register 10 (CSIC10) to the default status (00H)	p. 175 ☐
			P13/TxD6	To use P13/TxD6 as general-purpose port, clear bit 0 (TXDLV6) of synchronous serial interface control register 6 (ASICL6) to 0 (normal output of TxD6).	p. 175 ☐
	Hard		Port 2	Make the AV_{REF} pin the same potential as the V_{DD} pin when port 2 is used as a digital port.	p. 181 ☐
	Soft			For the 38-pin products of 78K0/KC2, be sure to set bits 6 and 7 of PM2 to “1”, and bits 6 and 7 of P2 to “0”.	p. 182 ☐
	Hard		P31/INTP2/ OCD1A	In the product with an on-chip debug function (μPD78F05xxD and 78F05xxDA), be sure to pull the P31/INTP2/OCD1A pin down before a reset release, to prevent malfunction.	p. 183 ☐
				Process the P31/INTP2/OCD1A pin of the products mounted with the on-chip debug function (μPD78F05xxD and 78F05xxDA) as follows, when it is not used when it is connected to a flash memory programmer or an on-chip debug emulator (see the table on p.183).	p. 183 ☐
	Soft		Port 4	For the 38-pin products of 78K0/KC2, be sure to set bits 0 and 1 of PM4 and P4 to “0”.	p. 187 ☐
	Hard		P60, P61	A through current flows through P60 and P61 if an intermediate potential is input to these pins, because the input buffer is also turned on when P60 and P61 are in output mode. Consequently, do not input an intermediate potential when P60 and P61 are in output mode.	p. 190 ☐
			P62	A through current flows through P62 if an intermediate potential is input to this pin, because the input buffer is also turned on when P62 is in output mode. Consequently, do not input an intermediate potential when P62 is in output mode.	p. 191 ☐
	Soft		Port 7	For the 38-pin products of 78K0/KC2, be sure to set bits 2 and 3 of PM7 and P7 to “0”.	p. 195 ☐